



TO-220F Plastic-Encapsulate MOSFETS

PF07N65

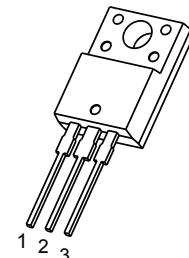
N-Channel Power MOSFET

V _{(BR)DSS}	R _{DS(on)HMD}	I _D
650V	1.1Ω@10V	7.4A

GENERAL DESCRIPTION

This advanced high voltage MOSFET is designed to stand high energy in the avalanche mode and switch efficiently. This new high energy device also offers a drain-to-source diode fast recovery time. Designed for high voltage, high speed switching applications such as power supplies, converters, power motor controls and bridge circuits.

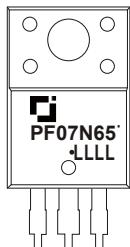
TO-220F



FEATURE

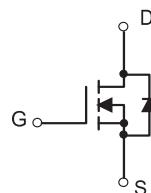
- High Current Rating
- Lower R_{DS(on)}
- Lower Capacitance
- Lower Total Gate Charge
- Tighter V_{SD} Specifications
- Avalanche Energy Specified
- Fast Switching Capability

MARKING



PF07N65 = Device code.
Solid dot = Green molding compound device,
if none, the normal device.
XXXX = Code.

EQUIVALENT CIRCUIT



ABSOLUTE MAXIMUM RATINGS (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	650	V
Gate-Source Voltage	V _{GS}	±30	V
Continuous Drain Current	I _D ^①	7.4	A
Pulsed Drain Current	I _{DM} ^②	29.6	A
Single Pulsed Avalanche Energy	E _{AS} ^③	500	mJ
Maximum Power Dissipation	P _D ^①	50	W
Thermal Resistance from Junction to Ambient	R _{θJA}	62.5	°C/W
Thermal Resistance from Junction to Case	R _{θJC} ^①	2.5	°C/W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150	°C

MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25^\circ\text{C}$ unless otherwise specified

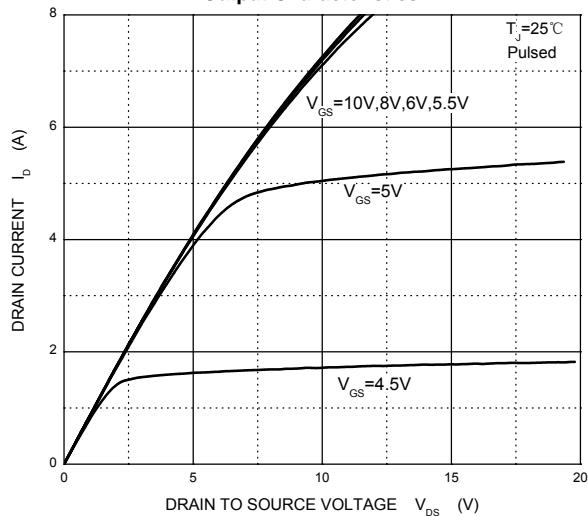
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	650			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = 520\text{V}, T_J = 25^\circ\text{C}$			10	μA
		$V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$			20	
Gate-body leakage current	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 30\text{V}$			± 100	nA
On characteristics^④						
Gate-threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	2	3.2	4	V
Static drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 3.7\text{A}$		1.1	1.3	Ω
Forward transconductance	g_{fs}	$V_{\text{DS}} = 40\text{V}, I_{\text{D}} = 3.7\text{A}$	5			S
Dynamic characteristics^{④ ⑤}						
Input capacitance	C_{iss}	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		1130	2260	pF
Output capacitance	C_{oss}			91	182	
Reverse transfer capacitance	C_{rss}			3	6	
Gate resistance	R_g		$f = 1\text{MHz}$		4.6	
Switching characteristics^{④ ⑤}						
Total gate charge	Q_g	$V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 520\text{V}, I_{\text{D}} = 7.4\text{A}$		23	46	nC
Gate-source charge	Q_{gs}			4.7	9.4	
Gate-drain charge	Q_{gd}			8.5	17	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 325\text{V}, V_{\text{GS}} = 10\text{V}, R_g = 25\Omega, I_{\text{D}} = 7.4\text{A}$		70		ns
Turn-on rise time	t_r			170		
Turn-off delay time	$t_{\text{d}(\text{off})}$			140		
Turn-off fall time	t_f			130		
Drain-Source Diode Characteristics						
Drain-source diode forward voltage	$V_{\text{SD}}^{\text{(4)}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 7.4\text{A}$			1.4	V
Continuous drain-source diode forward current	$I_{\text{S}}^{\text{(1)}}$				7.4	A
Pulsed drain-source diode forward current	$I_{\text{SM}}^{\text{(2)}}$				29.6	A

Notes:

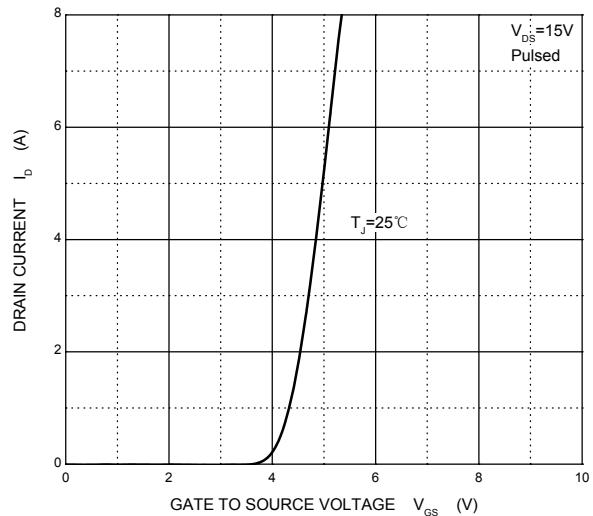
1. $T_c = 25^\circ\text{C}$ Limited only by maximum temperature allowed.
2. $P_w \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$.
3. EAS condition: $V_{\text{DD}} = 50\text{V}, V_{\text{GS}} = 10\text{V}, L = 10\text{mH}, R_g = 25\Omega$ Starting $T_J = 25^\circ\text{C}$.
4. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
5. Guaranteed by design, not subject to production.

Typical Characteristics

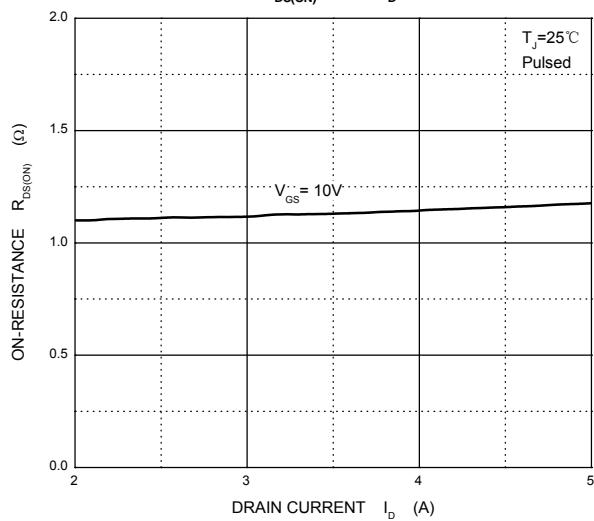
Output Characteristics



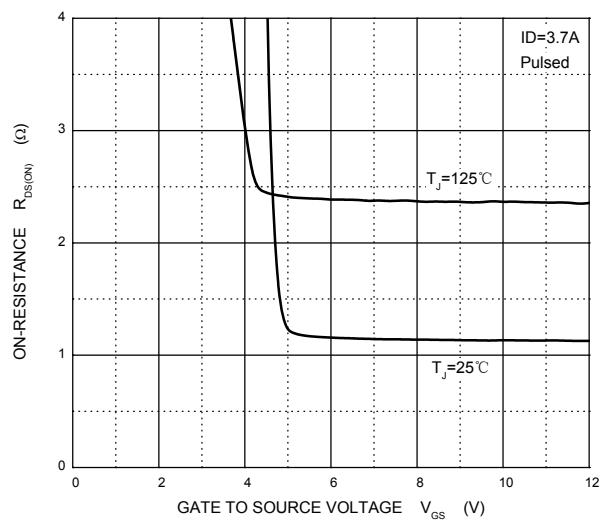
Transfer Characteristics



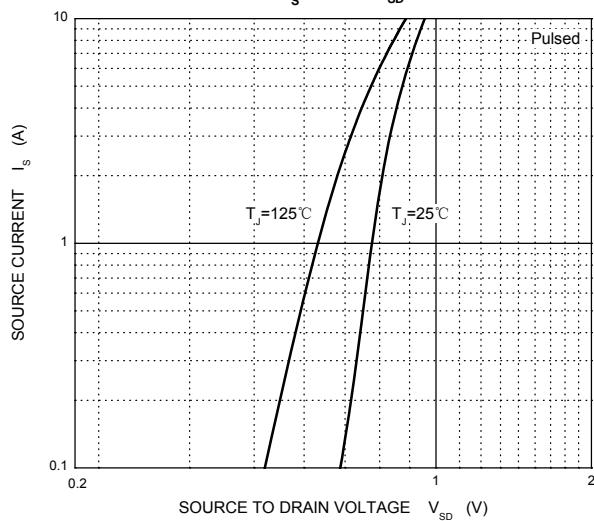
$R_{DS(ON)}$ — I_D



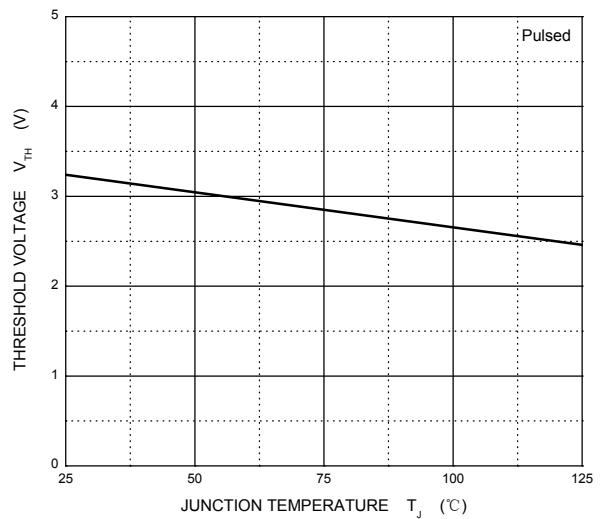
$R_{DS(ON)}$ — V_{GS}



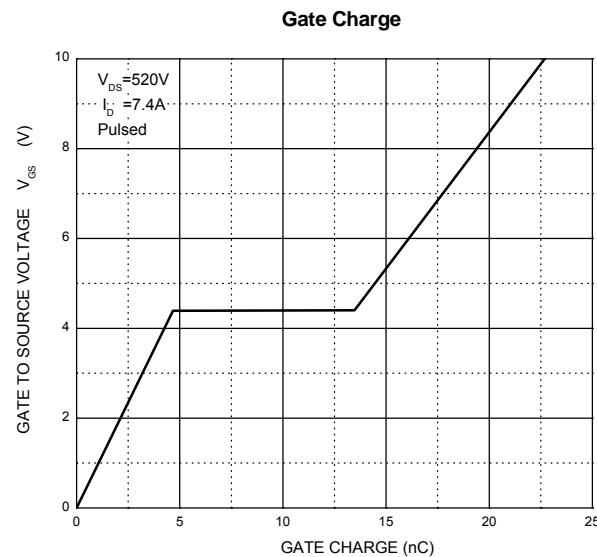
I_S — V_{SD}



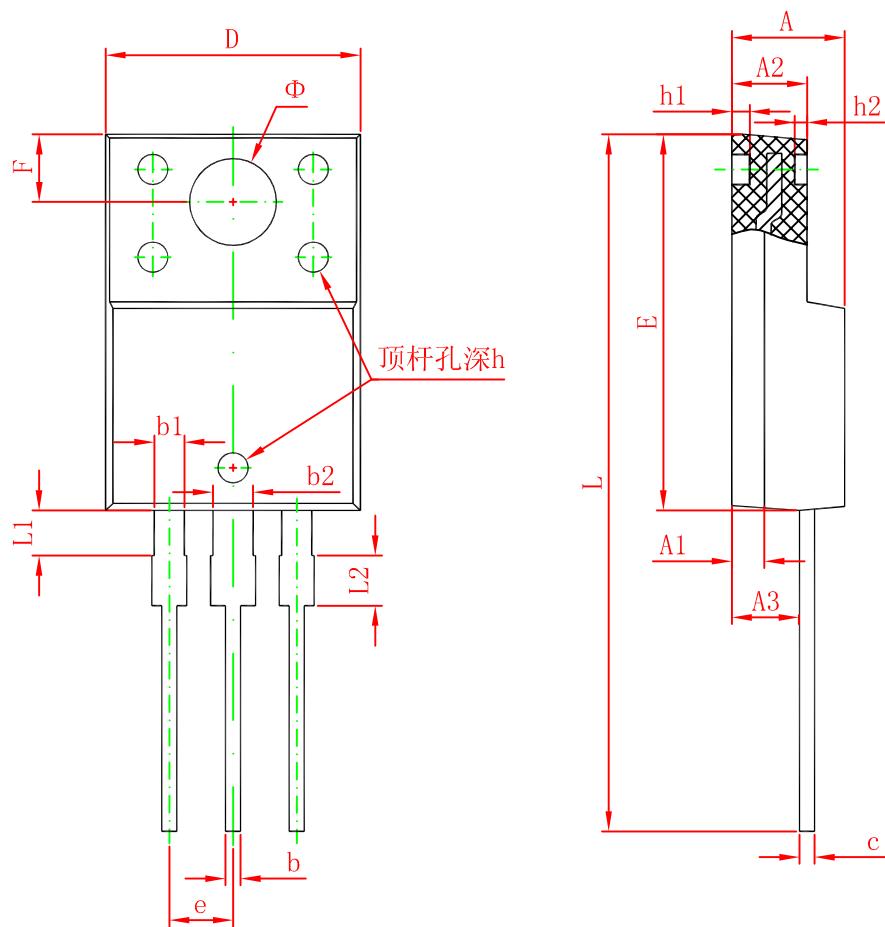
Threshold Voltage



Typical Characteristics



TO-220F Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300	REF.	0.051	REF.
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
Φ	3.500 REF.		0.138 REF.	
h	0.000	0.300	0.000	0.012
h1	0.800 REF.		0.031 REF.	
h2	0.500 REF.		0.020 REF.	
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	0.900	1.100	0.075	0.083